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IJARSE, Vol. No.3, Issue No.11, November 2014

ISSN-2319-8354(E)

SYNTHESIS AND STRUCTURAL CHARACTERIZATION OF ELECTRO DEPOSITED NICKEL COBALT TUNGSTEN ALLOY THIN FILM AT DIFFERENT TEMPERATURE

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ABSTRACT

Nano crystalline Ni-Co-W alloy thin films were deposited by electrodeposition method on the copper substrate at different temperature .The structural, chemical composition, surface morphology and mechanical property of electro deposited Ni-Co-W thin films were studied. EDAX investigation gives the chemical composition of the coated films. The structural and surface morphology of the coated film have been analyzed by using X-ray diffractometer (XRD) and Scanning Electron Microscope (SEM) respectively. The mechanical properties of coated films were studied by Vickers hardness test. The electroplated thin films were strongly adherent to the substrate. This was observed from bend and scratch test. The deposits of thin films were found to be smooth and nano crystalline. All the electro deposited Ni-Co-W films exhibit BCC crystalline structure with crystalline size in the order of nano scale. The films obtained from higher bath temperature were found to have higher value of Hardness .Generally CoNi based thin films have potential applications in the fabrication of MEMS and NEMS devices. Based on the magnetic properties of thin films may be used in MEMS devices. The average crystalline size of Ni-Co-W thin films were calculated from XRD is in range of 29.86 nm

Keywords: Thin Films, Characterization, Electrodeposition, Crystalline Size and Surface Morphology.

IJARSE, Vol. No.3, Issue No.11, November 2014

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I INTRODUCTION

In power electronics industry, CoNi oxide thin films are the suitable materials for the production of super capacitors. The Ni, Co, W, Fe, Cr based thin films have potential applications in the field of magnetic sensor technology, computer read/write heads, large scale integration (ULSI) devices, heads magnetic actuators, magnetic shielding, high performance transformer cores, micro electro mechanical systems (MEMS) and Nano electro mechanical systems (NEMS) and based on their compositions, structural properties and magnetic properties [1-5]. In the current MEMS technologies, CoNi, CoW, NiFe and NiW thin film alloys are used because those films can exhibit excellent magnetic properties [1-2]. The alloy thin films can be synthesized through several methods such as thermal decomposition method, spray pyrolysis and electrodeposition method. In this current investigation, the electrodeposition method has been chosen for coating the Ni-Co-W thin films. Because compared to other coating methods electrodeposition has several advantages. The electrodeposition method is the simplest, most economical, reliable and reproducible technique. Electrodeposition of CoNi films and their studies were carried out by few numbers of researchers [15-20]. Normally CoNi thin films have good magnetic properties so that it can be used in various applications. If we add third element to CoNi the structural, mechanical and magnetic properties may be enhanced. In this present work we planned to analyze the effect of W on CoNi thin films with different temperature. W is a good candidate as it is highly corrosion resistant metal and also has high mechanical strength This paper summarizes the synthesis and structural characterizations of electroplated crystalline Ni-Co-W thin films.

II EXPERIMENTAL PART

The bath composition of Ni-Co-W alloy thin film is shown in Table 1.The thin films are successfully coated by electrodeposition method. In this investigation a copper plate of size 1.5 cm as breath and 7.5cm as length and same size of stainless steel were used as substrates.. Copper substrate act as the cathode and pure stainless steel act as the anode. Both cathode and anode were pre- treated by washing with soap and soaking in 15% H₂SO₄ for 2 minutes. Just before the deposition both the plates are degreased by acetone. The electroplating bath prepared by all the reagent grade chemicals was dissolved in triple distilled water. The pH value of the bath was adjusted to 6 by adding few drops of ammonia solution. The Ni-Co-W thin films were electro deposited on the copper substrate by applying a current of 25 mA for 15 minutes at 30°C,50°C ,70°C and 90°C. After 15 minutes the cathode was carefully removed from the bath and dried for few minutes. The mask on the surface of cathode was also given by using adherent tape.

The structure and morphology of the Ni-Co-W thin films were studied with the help of XRD and SEM. The film composition was measured by Energy-dispersive X-ray Spectroscopy (EDAX).Hardness of the film was measured by Vickers Hardness Test (VHN).The thicknesses of the films were determined by cross sectional view of SEM images. The Electrodeposition bath details of thin films is given in table 1

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| S. No | Name of the chemicals and parameters | Data g/1 |
|-------|--------------------------------------|----------------------|
| 1. | Nickel Sulphate | 30 |
| 2. | Cobalt Sulphate | 15 |
| 3. | Sodium Tungstate | 10 |
| 4. | Sodium citrate | 40 |
| 5. | NaCl | 5 |
| б. | Boric acid | 20 |
| 7. | pH value | 6 |
| 8. | Time Duration | 15 min |
| 9 | Temperature | 30°C,50°C ,70°C and |
| | | 90°C |
| 10. | Current density | 3 mA/cm ² |
| | | |

Table 1: Electrodeposition bath details of thin films

III RESULT AND DISCUSSION

3.1 Composition of The Electro Deposited Thin Films

The chemical composition of the electroplated thin films is analyzed by EDAX spectrum. The EDAX spectrum of Ni-Co-W thin films is shown in fig 1. The EDAX data of thin films are shown in Table 2.

| S. No | Temperature | Co Wt% | Ni Wt% | W Wt% |
|-------|-------------|-----------|-----------|----------|
| 1. | 30°C | 64.21 | 7.68 | 28.12 |
| 2 | 50°C | 57.48 | 18.98 | 23.54 |
| 3 | 70°C | 55.39 | 37.68 | 6.93 |
| 4 | 90°C | 51.35 | 38.27 | 10.38 |

Table 2: EDAX analysis of thin films

EDAX result showed that the films obtained at higher temperature have low Tungsten content. The lowest Tungsten content of 6.93wt% was obtained at temperature 70°C



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ISSN-2319-8354(E)

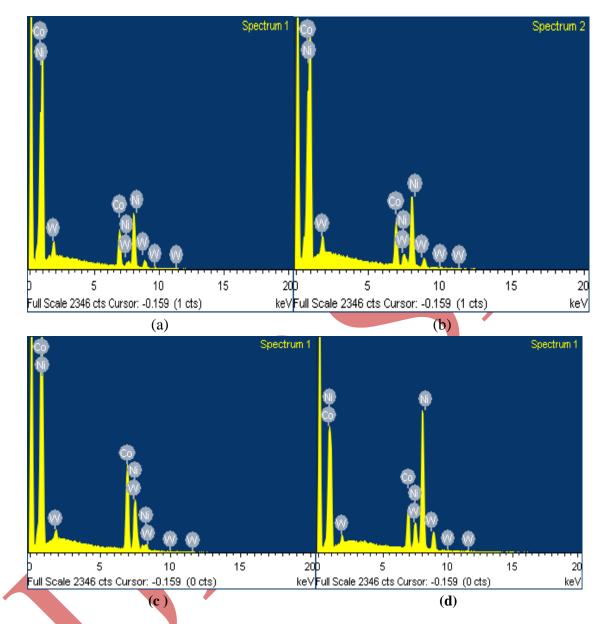
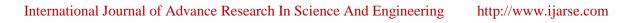


Figure 1: EDAX spectrum of Ni-Co-W thin film for different bath temperature

temperatures (a) 30°C (b) 50°C (c) 70°C (d) 90°C

IV SURFACE MORPHOLOGY OF THIN FILMS

The surface morphology of the electroplated Ni-Co-W thin films with different temperature is analyzed by using SEM pictures and are shown in fig 2. The electroplated thin films are smooth, uniform and adherent with substrate. The thin films are crack free, bright and uniform. From SEM analysis we conclude that the formation of thin films on the copper substrate is uniform in nature. The thickness of the coated thin films is increasing with increasing temperature.



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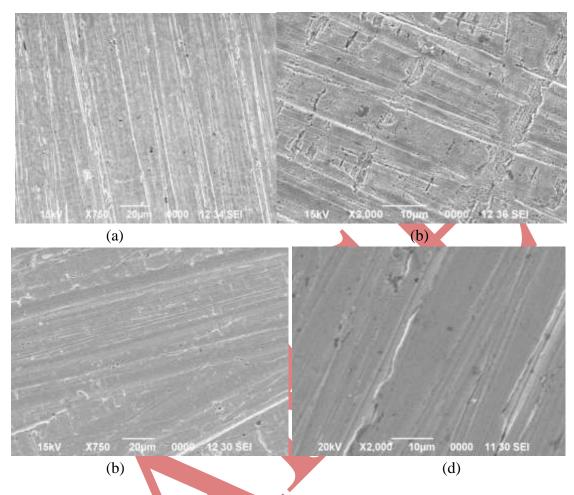


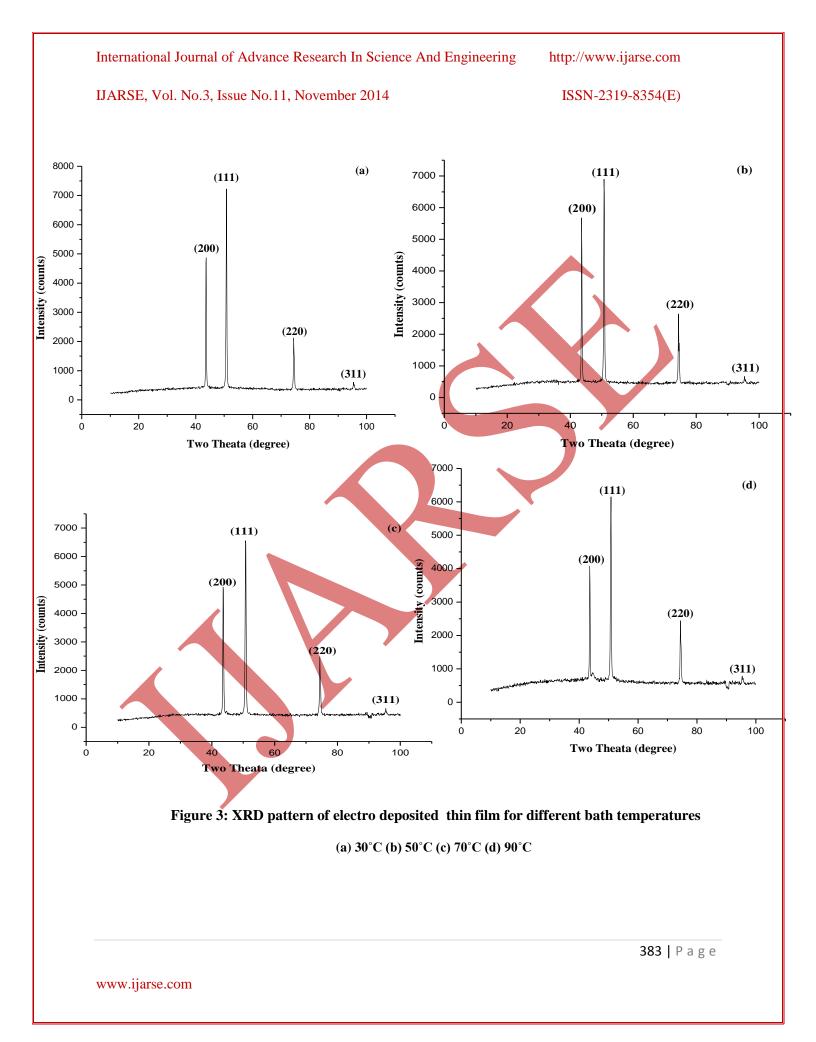
Figure 2: SEM images for Electro deposited Ni-Co-W thin film for different bath temperatures (a) 30°C (b) 50°C (c) 70°C (d) 90°C

V STRUCTURAL PROPERTIES OF Ni-Co-W THIM FILMS

The crystal structure of the electro deposited Ni-Co-W alloy thin films were determined by XRD analysis. X- ray diffraction patterns of films obtained at different temperatures were shown in fig 3. The presence of sharp peaks in XRD pattern reveals that the films are crystalline in nature. Crystalline size of the deposits of Ni-Co-W thin films were calculated from XRD pattern using formula

(D=0.954λ/βcosθ) -----(1)

The data's obtained from XRD analysis are compared with standard JCPDS data and found to have BCC crystalline structure with three predominant peaks of (200), (111), (220) and (311). These values clearly show that the crystalline sizes of the deposits obtained by electro deposition process are in the nano scale. The crystal size of alloy films are tabulated as shown in Table 3. The average crystalline size of the thin films are around 29.86 nm.



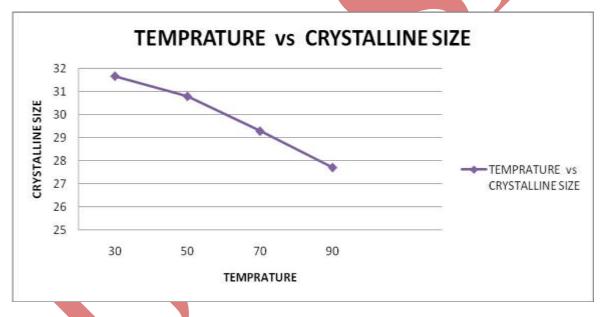
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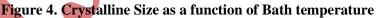
ISSN-2319-8354(E)

From XRD we conclude that the films have nano crystalline phase. Because Nano scale level is the dominant factor to decide the magnetic properties. When we increase the bath temperature the crystalline size of thin films decrease due to onset orientation of crystals during electrodeposition. So we planned to investigate the magnetic properties of thin films with different bath temperature and different tungsten concentration.

| S. | Temperature | 20 | d | Particle | Strain | Dislocation | Thickness |
|----|-------------------|--------|---------------------------|----------|-------------|-------------------|-----------|
| No | (⁰ C) | (deg) | (A ⁰) | size, D | (10^{-3}) | density | (µm) |
| | | | | (nm) | | $(10^{14} / m^2)$ | |
| 1 | 30 | 50.75 | 1.7972 | 31.67 | 1.1501 | 9.9702 | 4.5 |
| 2 | 50 | 50.27 | 1.7984 | 30.79 | 1.1830 | 10.5487 | 4.9 |
| 3 | 70 | 50.71 | 1.7985 | 29.28 | 1.2441 | 11.6662 | 5.7 |
| 4 | 90 | 50.731 | 1.7981 | 27.70 | 1.3149 | 13.0323 | 5.8 |
| | | | | | | | |

Table 3: Crystalline size of alloy thin films





VI MECHANICAL PROPERTIES

Adhesion of the electrodeposited thin film with the substrate is tested by bend test. Initially the equal lines are drawn on the surface of the Ni-Co-W coated film by pin. After that the adhesive tape is pasted over the coated surface and then finally pulls out the tape from the surface of coated Ni-Co-W thin films. If the film comes with tape then the adhesion is poor. This test showed that the film is having good adhesion with the substrate. Hardness of the films was examined by using a Vickers hardness tester by the diamond intender method. The results show that the

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hardness increases with increasing bath temperature. The dependence of Vickers hardness and Bath temperature is shown fig 5.

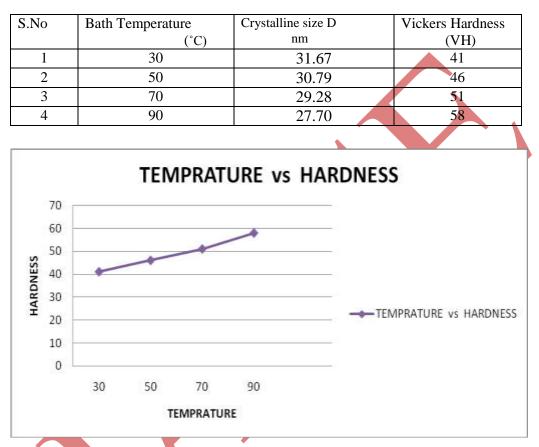


Table 4. Mechanical Properties of Electro deposited Ni-Co-W thin film

Figure 5. Vickers Hardness as a function of bath temperature

VII CONCLUSION

The Ni-Co-W magnetic thin films were successfully synthesized by electro deposition at different bath temperatures 30°C, 50°, 70°C and 90°C. The nano crystalline films obtained at different temperature are crack free, bright and uniform. BCC was the dominant structure of electro deposited Ni-Co-W thin films. The crystalline sizes of the deposits obtained by electro deposition process are in the nano scale. The average crystalline size of Ni-Co-W films is around 29.86 nm. Hardness is increases with increasing bath temperature. This article summaries the optimized operating condition of electroplated bath. Based on their magnetic properties of thin films, these films may be used in various electronic devices including high density recording media, magnetic actuators, magnetic shielding,

IJARSE, Vol. No.3, Issue No.11, November 2014

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magnetic writing heads, VLSI, high performance transformer cores and MEMS. Because of the potential applications of CoNi based thin films in various industrial areas .

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